

24V 4A PWM STEP-UP DC-DC CONVERTER

GENERAL DESCRIPTION

The HXC6240 devices are high-performance, fixed frequency, current-mode PWM step-up DC/DC converters that incorporate internal power MOSFETs. The HXC6240 includes an integrated 100-m Ω power switch that supports peak currents of up to 4A. The device is capable of providing an output voltage up to 24 V.

The HXC6240 uses peak current control topology to regulate the output voltage. In moderate to heavy load condition, the HXC6240 works in the pulse width modulation (PWM) mode. In light load condition, the device works in the pulse frequency modulation (PFM) mode to improve the efficiency.

The HXC6240 utilizes simple external loop compensation allowing optimization between component size, cost and AC performance across a wide range of applications. Additional functions include an externally programmable soft-start function for easy inrush current control, internal overvoltage protection (OVP), cycle-by-cycle current limit protection, under voltage lock-out and thermal shutdown.

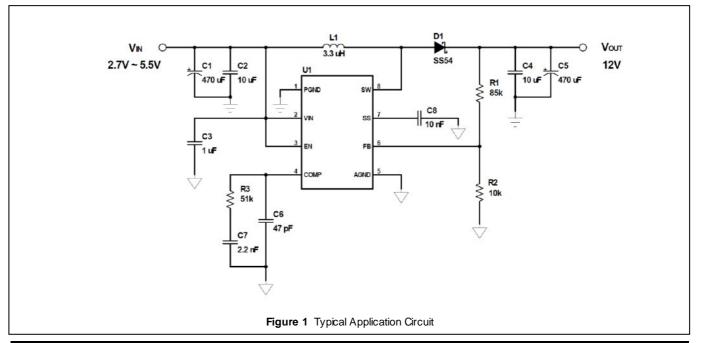
The HXC6240 is available in the small SOIC8-EP package.

FEATURES

- Input Voltage Range: 2.7 to 5.5V
- Adjustable Output Voltage Up to 24V
- 4A Switch Current
- Up to 85% Efficiency at V_{IN} = 4.2V, V_{OUT} = 12V, and I_{OUT} = 0.7A
- Internal 24V 100-mΩ Power MOSFET
- 0.1µA Current into VIN Pin during Shutdown
- 800kHz Frequency
- Built-in Over-Voltage Protection (OVP)
- Open Protection
- Programmable Soft-Start Function
- Thermal Shutdowns
- Under-Voltage-Lockout
- Cycle-by-Cycle Overcurrent Protection
- SOIC8-EP Package

APPLICATIONS

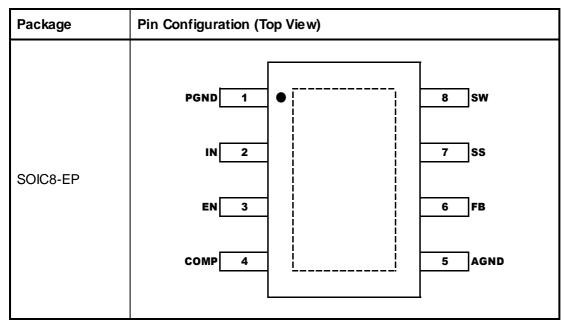
- Battery-Powered Equipment (Bluetooth[™] Speaker; E-Cigarette; Quick Charge Power Bank)
- Portable POS Terminal
- TFT LCD Monitors
- Set-Top Boxes
- DSL and Cable Modems and Routers



TYPICAL APPLICATION CIRCUIT



PIN CONFIGURATION



PIN DESCRIPTION

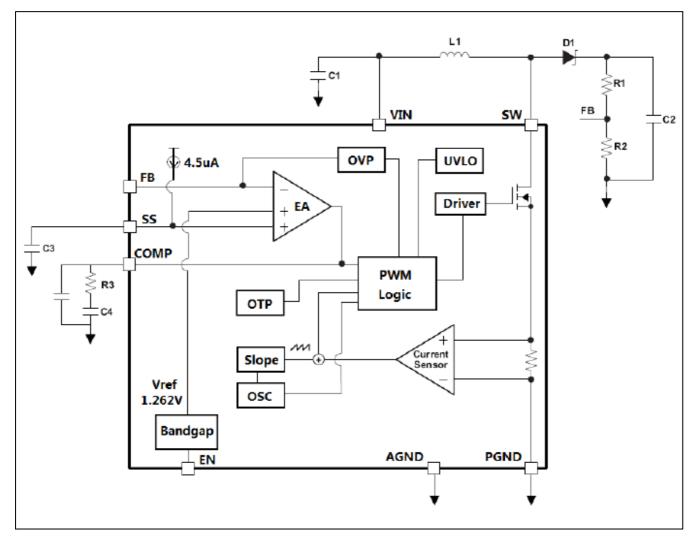
No.	Pin	Description	
1	PGND	Power Ground	
2	IN	Supply Input	
3	EN	Enable Control. Connect to a logic high level to enable the IC. Connect to a logic low level to disable the IC. When unused, connect EN pin to IN (do not leave pin floating).	
4	COMP	Error Amplifier Compensation Node	
5	AGND	Analog Ground	
6	FB	Feedback Input. Connect this pin a resistor divider from the output to set the output voltage. FB is regulated to 1.262V.	
7	SS	Soft Start Control Input. Connect a capacitor from this pin to Ground to set soft-start timing duration. SS is discharged to ground in shutdown. SS may be left unconnected if soft start is not desired.	
8	sw	Switch Output. Connect this pin to the inductor and the schottky diode. To minimize EMI, minimize the PCB trace path between this pin and the input bypass capacitor.	
-	Exposed Pad	Connected to Ground	



ORDERING INFORMATION Industrial Range: -40°C to +125°C

Order Part No.	Package	QTY		
HXC6240CB-13GTR HXC6240CB-GT	SOIC8-EP	2500/Reel 100/Tube		

FUNCTIONAL BLOCK DIAGRAM





ABSOLUTE MAXIMUM RATINGS

SW to Ground	-0.3V ~ 28V		
V _{IN} , EN, FB, SS, CO	-0.3V ~ 6.5V		
Continuous SW Curr	Internally Limited		
Total power dissipati	1.5w (T _S ≤100°C)		
Maximum junction te	150°C		
Storage temperature	-65°~+150°C		
Operating temperatu	-40°C~+125°C		
	Junction to Ambient, R _{th-JA}	60 °C/w	
Resistance	Junction to Case, R _{th-JC}	15 °C/w	
ESD (HBM)	2000 V		
ESD (CDM)	200 V		
ESD (FICDM)	1500 V		
Latch-up	+/- 100mA		

Note:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS (TBD)

Test condition is $T_A = -40^{\circ}C \sim +125^{\circ}C$. Typical values are at $T_A = 25^{\circ}C$, unless otherwise specified.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V _{IN}	Input voltage operation range		2.7		5.5	V
UVLO	Under voltage lockout threshold	V _{IN} Rising		2.5		V
	Under voltage lockout hysteresis			200		mV
lq	Chip quippoont gurrent	V _{IN} =3.6V, V _{FB} =1.4V, Non- switching		0.30	0.35	mA
	Chip quiescent current	V _{IN} =3.6V, V _{FB} =1.0V, Switching		3	5	
I _{SHDN}	Supply current in shutdown	EN=GND		0.1	1.0	uA
f_{REQ}	Switching frequency			800		kHz
DC	Maximum duty cycle		90			%
V_{FB}	Feedback voltage		1.23	1.26	1.29	V
I _{FB}	Feedback input current			0	80	nA
LNR	Feedback voltage line regulation	V_{FB} from 2.7V to 5.5V		0.05	0.15	%/V
I _{CL}	Switching peak current limit	V_{IN} =3.6V, Duty cycle = 70%	3.5	4.0		А
R _{DSON}	Switching ON resistance	V_{IN} =3.6V, V_{SW} =12V, Duty cycle = 70%		100		mΩ
I _{SW}	Switch leakage current	V _{SW} =12V, EN=GND			15	uA
I _{SS}	Soft start pin bias current	V _{SS} =1.2V	2.0	4.5	7.0	uA
V _{IH}	EN pin logic high		1.4			V
V _{IL}	EN pin logic low				0.4	V
R _{EN}	EN pull down resistor			1		MΩ
T_{SD}	Thermal shutdown temperature			150		°C
$T_{SD_{HYS}}$	Thermal shutdown hysteresis			15	1	°C



APPLICATION INFORMATION

The HXC6240 are highly efficient step-up DC/DC converters that employ a current mode, fixed frequency pulse-width modulation (PWM) architecture with excellent line and load regulation. The HXC6240 operate at constant switching frequency under medium to high load current conditions. At light loads, these devices operate in a pulse-skipping mode in order to improve light-load efficiency.

Soft-Start

The HXC6240 both offer a programmable soft-start function which minimizes inrush current during startup. The soft-start period is programmed by connecting a 10nF capacitor between SS and Ground. Operation of the soft-start function is as follows: when the IC is disabled, SS is actively discharged to Ground. Upon enabling the IC, CSS is charged with a 4.5μ A current so that the voltage at SS increases in a controlled manner. The peak inductor current is limited by the voltage at SS, so that the input current is limited until the soft-start period expires, and the regulator can achieve its full output current rating.

Setting the Output Voltage

The both feature external adjustable output voltages of up to 24V. To program the output voltage, simply connect a resistive voltage divider between the output, FB, and GND, with resistors set according to the following equation:

$$R_1 = R_2 \times \left[\left(\frac{V_{OUT}}{V_{FB}} \right) - 1 \right]$$

where V_{FB}=1.26V

Rectifier Selection

For optimal performance, the rectifier should be a Schottky rectifier that is rated to handle both the output voltage as well as the peak switch current.

Open Voltage Protection

The features internal automatic over-voltage protection, when feedback voltage is higher than 115%.

Overcurrent Protection

The HXC6240 has a cycle-by-cycle overcurrent limit protection that turns off the power switch once the inductor current reaches the overcurrent limit threshold. The PWM circuitry resets itself at the beginning of the next switch cycle. During an

$$V_{OUT} = \frac{V_{IN} \times \left(I_{CL} - \frac{I_{RIPPLE}}{2}\right) \times \eta}{I_{OUT}}$$

where

- V_{OUT} is the output voltage of the boost regulator.
- I_{OUT} is the output current of the boost regulator.
- V_{IN} is the input voltage of the boost regulator.
- I_{CL} is the input switching peak current limit of the boost regulator.
- I_{RIPPLE} is the inductor ripple current of the boost regulator.
- η is the power conversion efficiency.

Open Circuit Protection

Once the outputs achieve regulation, if the voltage at FB falls below 0.2V the controller will automatically disable, preventing the controller from running open-loop and potentially damaging the IC and load.

Shutdown

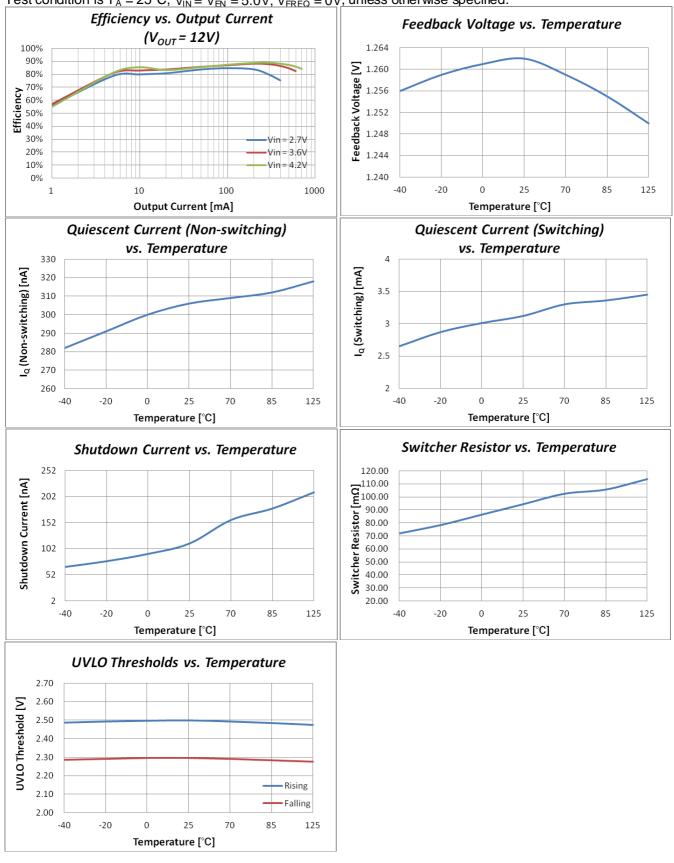
Drive EN low to disable the IC and reduce the supply current to just 0.1μ A. As with all non-synchronous step-up DC/DC converters, the external Schottky diode provides a DC path from the input to the output in shutdown. As a result, the output drops to one diode voltage drop below the input in shutdown.

The HXC6240 both feature integrated thermal overload protection. Both devices are automatically disabled when their junction temperatures exceed +150°C, and automatically re-enable when the die temperature decreases by 15°C.









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PACKAGE INFORMATION

SOIC8-EP

